

TURBOSWITCH™ ULTRA-FAST HIGH VOLTAGE DIODE

MAIN PRODUCT CHARACTERISTICS

I _{F(AV)}	60A / 2 x 60A
V _{RRM}	600V
t _{rr} (typ)	45ns
V _F (max)	1.5V

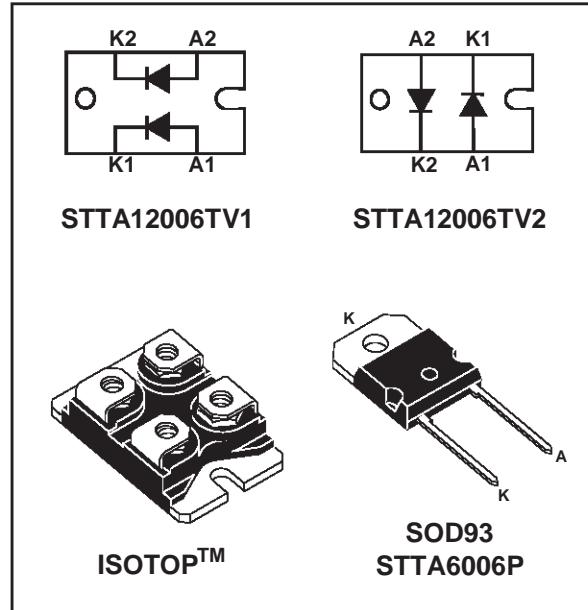
FEATURES AND BENEFITS

- SPECIFIC TO "FREEWHEEL MODE" OPERATIONS: FREEWHEEL OR BOOSTER DIODE.
- ULTRA-FAST RECOVERY.
- VERY LOW OVERALL POWER LOSSES IN BOTH THE DIODE AND THE COMPANION TRANSISTOR.
- HIGH FREQUENCY OPERATIONS.
- INSULATED PACKAGE : ISOTOP
Electrical insulation : 2500VRMS
Capacitance < 45 pF

DESCRIPTION

The TURBOSWITCH is a very high performance series of ultra-fast high voltage power diodes from 600V to 1200V.

TURBOSWITCH family, drastically cuts losses in both the diode and the associated switching IGBT or MOSFET in all "freewheel mode" operations and is particularly suitable and efficient in motor



control freewheel applications and in booster diode applications in power factor control circuitries. Packaged either in ISOTOP or SOD93 these 600V devices are particularly intended for use on 240V domestic mains.

ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive peak reverse voltage		600	V
V _{RSM}	Non repetitive peak reverse voltage		600	V
I _{F(RMS)}	RMS forward current		SOD93	A
			ISOTOP	A
I _{FRM}	Repetitive peak forward current	tp=5μs F=5kHz square	450	A
I _{FSM}	Surge non repetitive forward current	tp=10 ms sinusoidal	500	A
T _j	Maximum operating junction temperature		150	°C
T _{stg}	Storage temperature range		-65 to 150	°C

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STTA12006TV1/2 / STTA6006P

THERMAL AND POWER DATA (Per diode)

Symbol	Parameter	Test conditions		Value	Unit
$R_{th(j-c)}$	Junction to case thermal resistance	Per diode	0.85	°C/W	
		Total	0.47		
		Coupling	0.1		
P_1	Conduction power dissipation $I_{F(AV)} = 60A \quad \delta = 0.5$	SOD93	$T_c = 64^\circ C$	108	W
		ISOTOP	$T_c = 58^\circ C$		
P_{max}	Total power dissipation $P_{max} = P_1 + P_3 \quad (P_3 = 10\% P_1)$	SOD93	$T_c = 54^\circ C$	120	W
		ISOTOP	$T_c = 48^\circ C$		

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test conditions		Min	Typ	Max	Unit
V_F *	Forward voltage drop	$I_F = 60A$	$T_j = 25^\circ C$ $T_j = 125^\circ C$		1.25	1.75 1.5	V V
I_R **	Reverse leakage current	$V_R = 0.8 \times V_{RRM}$	$T_j = 25^\circ C$ $T_j = 125^\circ C$		5	200 12	μA mA
V_{to}	Threshold voltage	$I_p < 3.I_{AV}$	$T_j = 125^\circ C$			1.14	V
r_d	Dynamic resistance					6	$m\Omega$

Test pulses : * $t_p = 380 \mu s, \delta < 2\%$

** $t_p = 5 ms, \delta < 2\%$

To evaluate the maximum conduction losses use the following equation :
 $P = V_{to} \times I_{F(AV)} + r_d \times I_F^2(\text{RMS})$

DYNAMIC ELECTRICAL CHARACTERISTICS

TURN-OFF SWITCHING

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
t_{rr}	Reverse recovery time	$T_j = 25^\circ C$ $I_F = 0.5 A \quad I_R = 1A \quad Irr = 0.25A$ $I_F = 1 A \quad dI_F/dt = -50A/\mu s \quad V_R = 30V$		45	80	ns
I_{RM}	Maximum reverse recovery current	$T_j = 125^\circ C \quad V_R = 400V \quad I_F = 60A$ $dI_F/dt = -480 A/\mu s$ $dI_F/dt = -500 A/\mu s$		24	38	A
S factor	Softness factor	$T_j = 125^\circ C \quad V_R = 400V \quad I_F = 60A$ $dI_F/dt = -500 A/\mu s$		0.37		/

TURN-ON SWITCHING

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
t_{fr}	Forward recovery time	$T_j = 25^\circ C$ $I_F = 60 A, dI_F/dt = 480 A/\mu s$ measured at, $1.1 \times V_{Fmax}$			700	ns
V_{Fp}	Peak forward voltage	$T_j = 25^\circ C$ $I_F = 60A, dI_F/dt = 480 A/\mu s$			14	V

Fig. 1: Conduction losses versus average current.

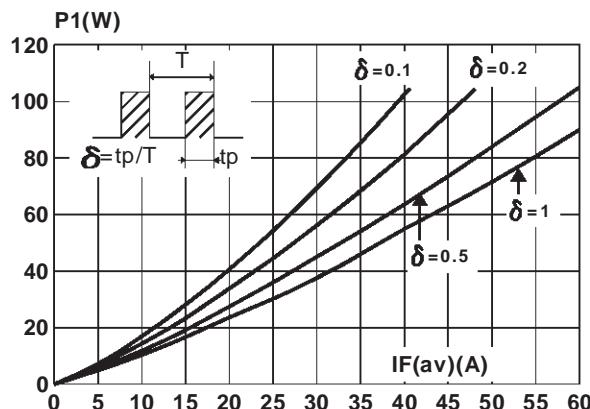


Fig. 3: Relative variation of thermal transient impedance junction to case versus pulse duration.

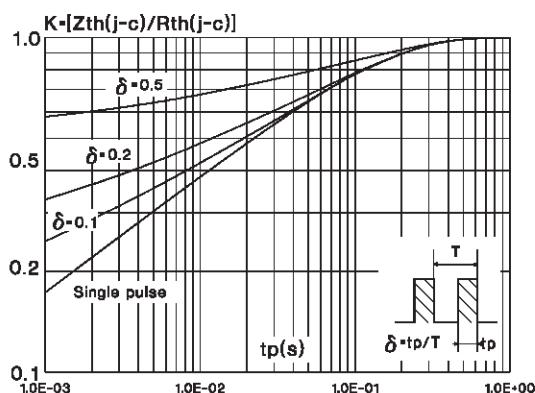


Fig. 5: Reverse recovery time versus $dI/F/dt$.

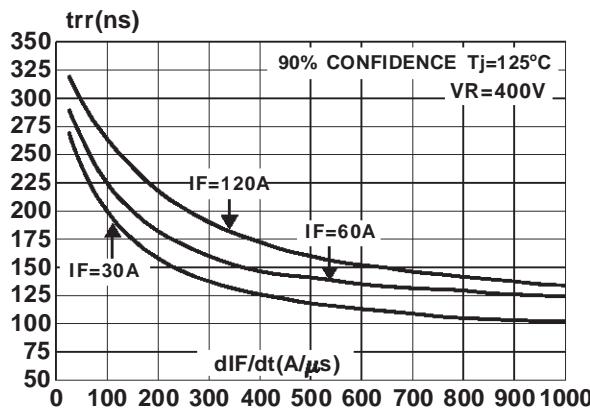


Fig. 2: Forward voltage drop versus forward current.

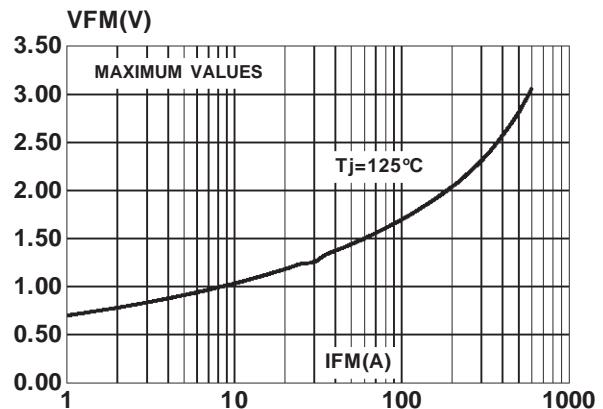


Fig. 4: Peak reverse recovery current versus $dI/F/dt$.

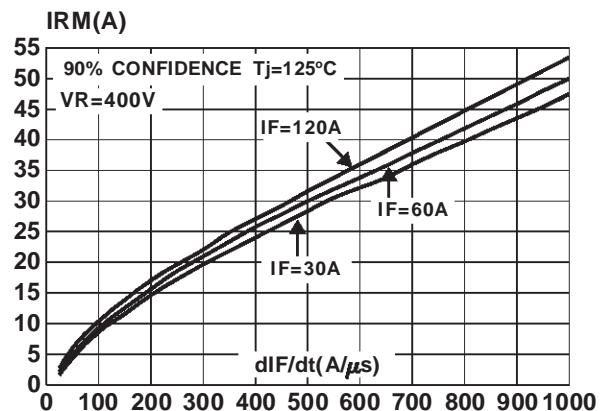
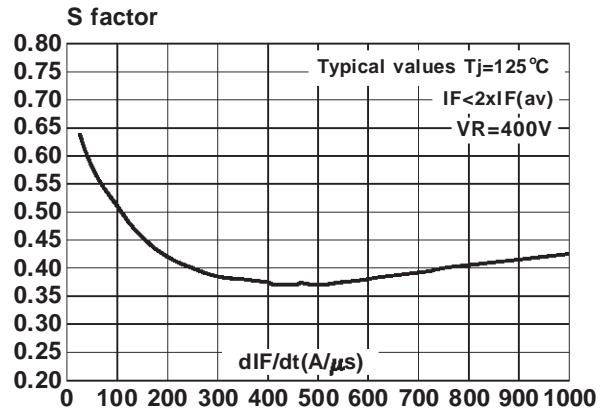


Fig. 6: Softness factor (tb/ta) versus $dI/F/dt$.



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Fig. 7: Relative variation of dynamic parameters versus junction temperature (reference $T_j=125^\circ\text{C}$).

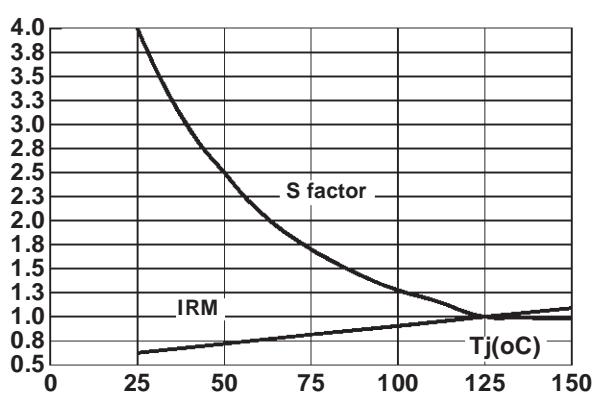


Fig. 8: Transient peak forward voltage versus $dI/F/dt$.

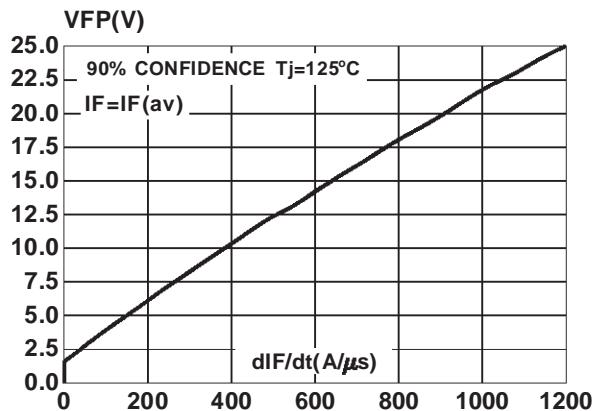
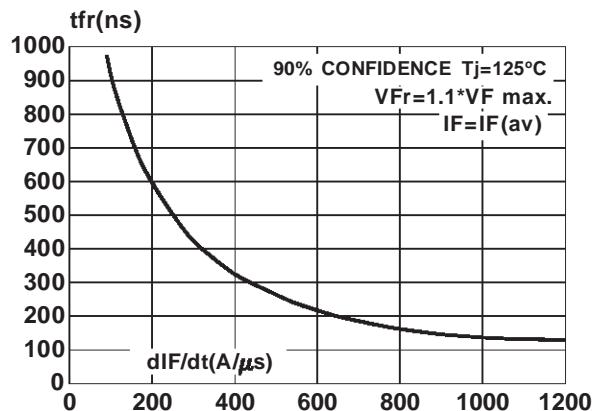


Fig. 9: Forward recovery time versus $dI/F/dt$.



APPLICATION DATA

The TURBOSWITCH is especially designed to provide the lowest overall power losses in any "FREEWHEEL Mode" application (Fig.A) considering both the diode and the companion

transistor, thus optimizing the overall performance in the end application.

The way of calculating the power losses is given below:

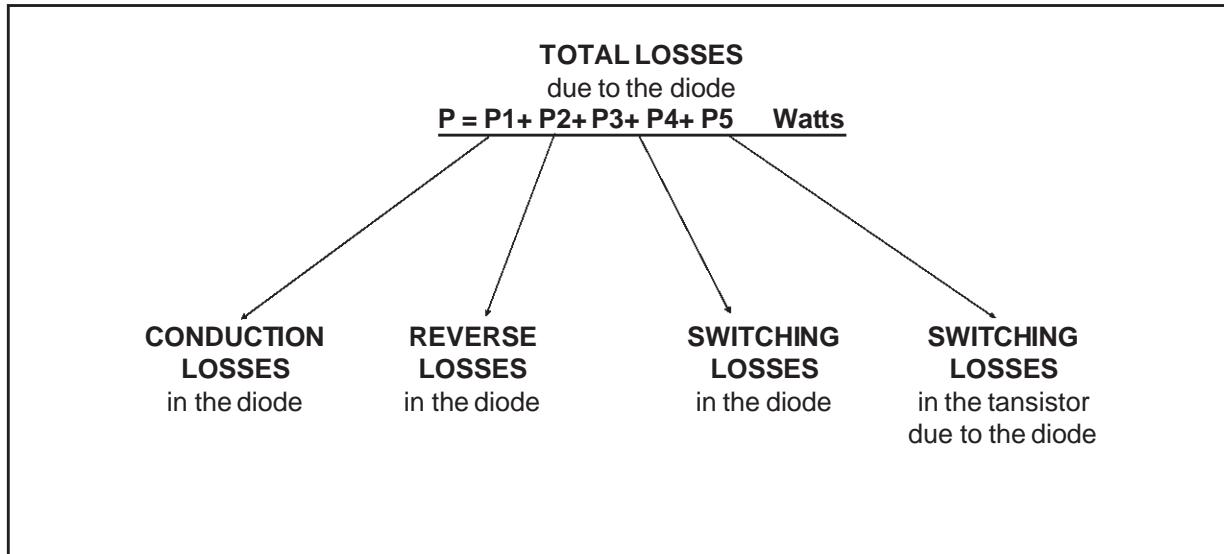
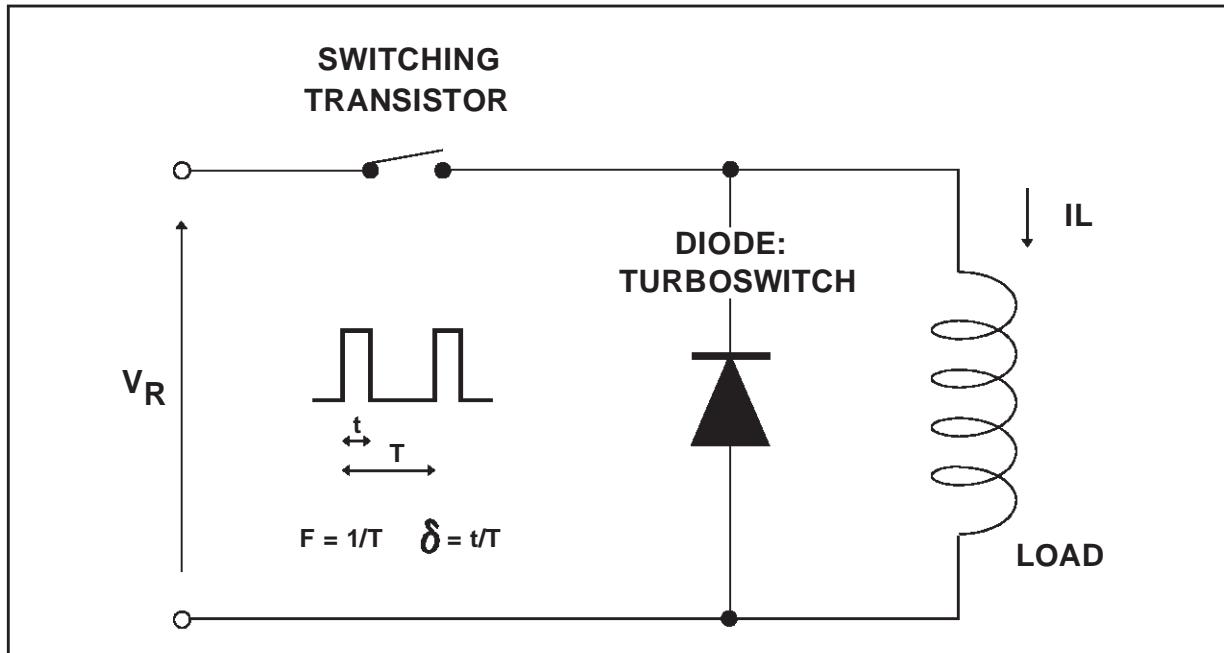
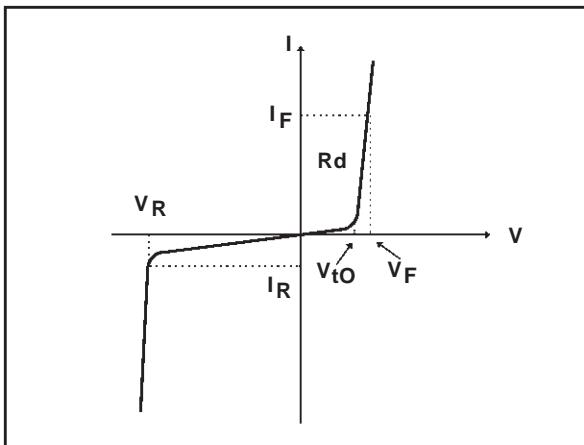


Fig. A : "FREEWHEEL" MODE.



APPLICATION DATA (Cont'd)

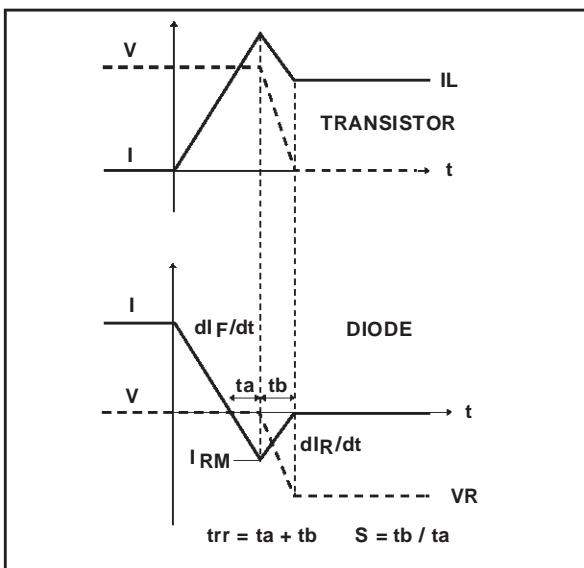
Fig. B: STATIC CHARACTERISTICS



Conduction losses:

$$P_1 = V_{t0} \cdot I_F(AV) + R_d \cdot I_F^2(\text{RMS})$$

Fig. C: TURN-OFF CHARACTERISTICS



Turn-on losses:

(in the transistor, due to the diode)

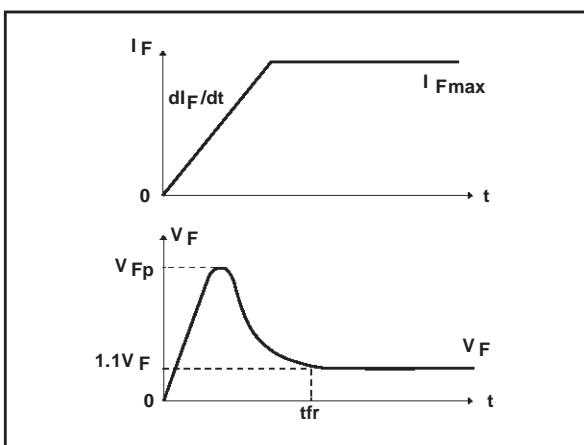
$$P_5 = \frac{V_R \times I_{RM}^2 \times (3 + 2 \times S) \times F}{6 \times dI_F/dt} + \frac{V_R \times I_{RM} \times I_L \times (S + 2) \times F}{2 \times dI_F/dt}$$

Turn-off losses (in the diode):

$$P_3 = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt}$$

P3 and P5 are suitable for power MOSFET and IGBT

Fig. D: TURN-ON CHARACTERISTICS

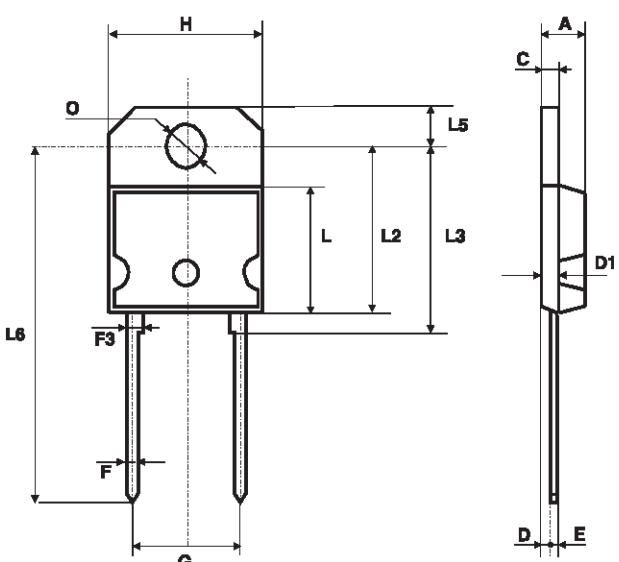


Turn-on losses:

$$P_4 = 0.4 (V_{FP} - V_F) \cdot I_{Fmax} \cdot t_{fr} \cdot F$$

PACKAGE MECHANICAL DATA
SOD93

REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.70		4.90	0.185		0.193
C	1.17		1.37	0.046		0.054
D		2.50			0.098	
D1		1.27			0.050	
E	0.50		0.78	0.020		0.031
F	1.10		1.30	0.043		0.051
F3		1.75			0.069	
G	10.80		11.10	0.425		0.437
H	14.70		15.20	0.578		0.598
L			12.20			0.480
L2			16.20			0.638
L3		18.0			0.709	
L5	3.95		4.15	0.156		0.163
L6		31.00			1.220	
O	4.00		4.10	0.157		0.161



The diagram shows the top view and side cross-section of the SOD93 package. Key dimensions are labeled: H (width), L (height), L2 (inner height), L3 (inner height), L5 (inner height), L6 (total height), F3 (lead thickness), F (lead width), G (lead pitch), C (lead height), D (lead thickness), D1 (lead width), E (lead thickness), and O (lead pitch). The top view also shows the chip area with dimensions L1, L4, and L5.

Cooling method : by conduction (C)

Recommended torque value : 0.8 m.N

Maximum torque value : 1m.N

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PACKAGE MECHANICAL DATA

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	11.80	12.20	0.465	0.480
A1	8.90	9.10	0.350	0.358
B	7.8	8.20	0.307	0.323
C	0.75	0.85	0.030	0.033
C2	1.95	2.05	0.077	0.081
D	37.80	38.20	1.488	1.504
D1	31.50	31.70	1.240	1.248
E	25.15	25.50	0.990	1.004
E1	23.85	24.15	0.939	0.951
E2	24.80 typ.		0.976 typ.	
G	14.90	15.10	0.587	0.594
G1	12.60	12.80	0.496	0.504
G2	3.50	4.30	0.138	0.169
F	4.10	4.30	0.161	0.169
F1	4.60	5.00	0.181	0.197
P	4.00	4.30	0.157	0.69
P1	4.00	4.40	0.157	0.173
S	30.10	30.30	1.185	1.193

Cooling method : by conduction (C)

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTA6006P	STTA6006P	SOD93	3.79g	30	Tube
STTA12006TV1	STTA12006TV1	ISOTOP	27g	10	Tube
STTA12006TV2	STTA12006TV2	ISOTOP	without screws	10	Tube

Epoxy meets UL94, V0

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